

8N70

Power MOSFET

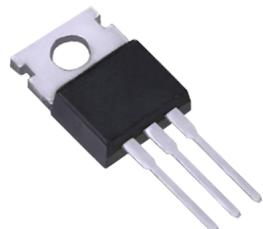
8A, 700V N-CHANNEL POWER MOSFET

■ DESCRIPTION

The UTC **8N70** is an N-channel power MOSFET using UTC's advanced technology to provide the customers with minimum on-state resistance, superior switching performance and withstand high energy pulse in the avalanche and commutation mode.

■ FEATURES

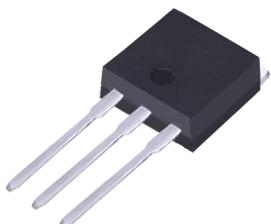
- * $R_{DS(ON)} \leq 1.4\Omega$ @ $V_{GS}=10V$, $I_D=4.0A$
- * High switching speed



TO-220



TO-220F



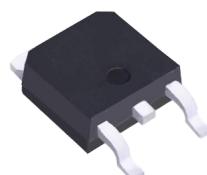
TO-262



TO-263



TO-251



TO-252

■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous $T_C=25^\circ\text{C}$	I_D	8	A
			4.8	A
	Pulsed (Note 5)	I_{DM}	32	A
Avalanche Current	Repetitive (Note 2)	I_{AR}	8	A
	Repetitive (Note 3)	I_{AS}	8	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	230	mJ
	Repetitive (Note 2)	E_{AR}	11.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.5	V/ns
Power Dissipation ($T_C=25^\circ\text{C}$)	TO-220/TO-263	P_D	147	W
	TO-220F/TO-220F1		49	
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 7.74\text{mH}$, $I_{AS} = 8\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 8\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

5. Limited by maximum junction temperature.

■ THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	°C/W
Junction to Case	TO-220	θ_{JC}	0.85	°C/W
	TO-263		0.85 (Note)	
	TO-220F/TO-220F1		2.55	

Note: Urface mounted on FR4 board $t \leq 10$ sec.

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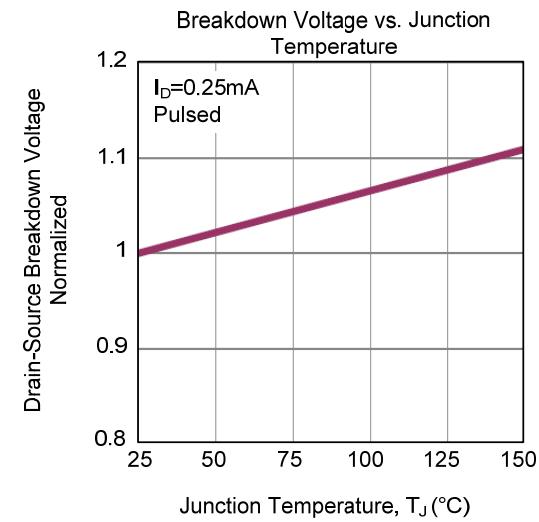
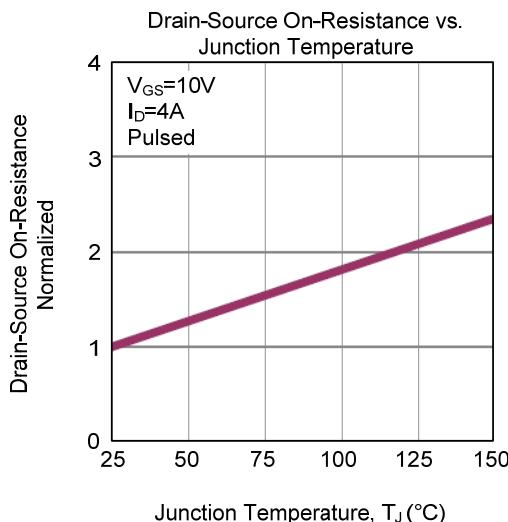
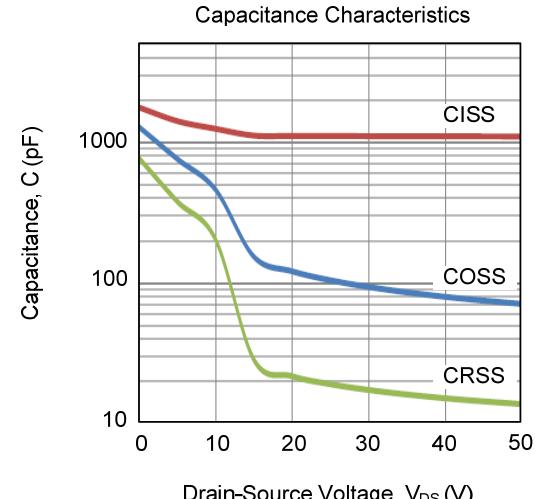
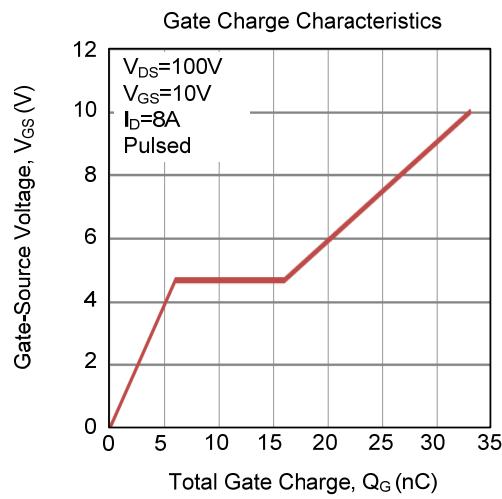
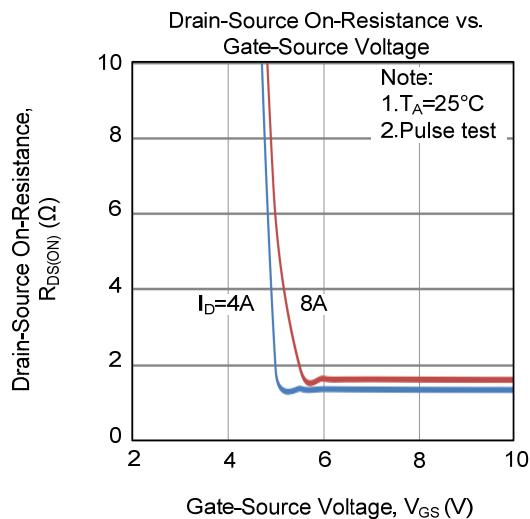
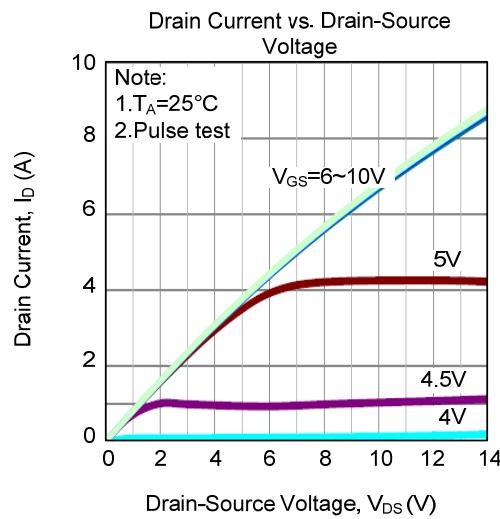
■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	700			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=700\text{V}, V_{GS}=0\text{V}$ $V_{DS}=560\text{V}, TC=125^\circ\text{C}$		10		μA
Gate-Source Leakage Current	Forward Reverse	$V_{GS}=+30\text{V}, V_{DS}=0\text{V}$ $V_{GS}=-30\text{V}, V_{DS}=0\text{V}$		+10		nA
				-10		nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=4.0\text{A}$		1.2	1.4	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1.0\text{MHz}$		1100		pF
Output Capacitance	C_{OSS}			105		pF
Reverse Transfer Capacitance	C_{RSS}			19		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{DS}=100\text{V}, V_{GS}=10\text{V}, I_D=8\text{A}$ $I_G=1\text{mA}$ (Note 1, 2)		33		nC
Gate to Source Charge	Q_{GS}			6		nC
Gate to Drain Charge	Q_{GD}			10		nC
Turn-ON Delay Time	$t_{D(\text{ON})}$	$V_{DD}=300\text{V}, V_{GS}=10\text{V}, I_D=10\text{A},$ $R_G=25\Omega$, (Note 1, 2)		15		ns
Rise Time	t_R			17		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$			110		ns
Fall-Time	t_F			47		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I_S	Integral reverse diode in the MOSFET			8	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				32	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_S=8\text{A}, V_{GS}=0\text{V}$			1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$I_S=8\text{A}, V_{GS}=0\text{V}, dI_F/dt=100\text{A}/\mu\text{s}$		380		ns
Body Diode Reverse Recovery Charge	Q_{rr}			4.7		μC

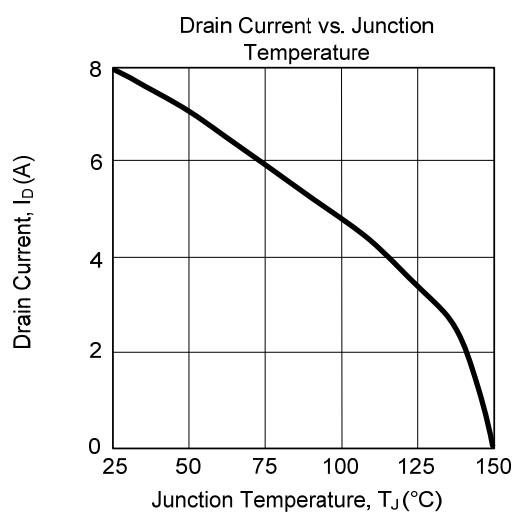
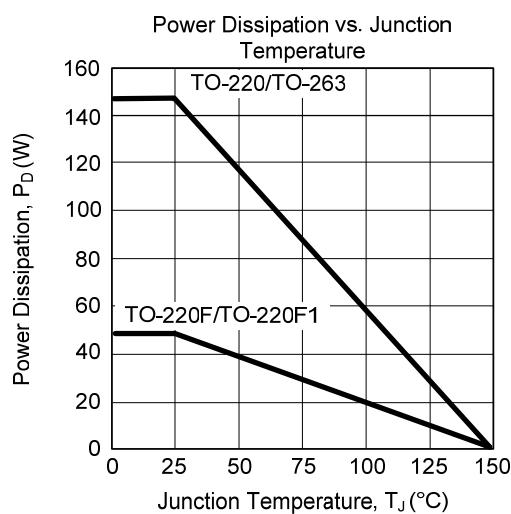
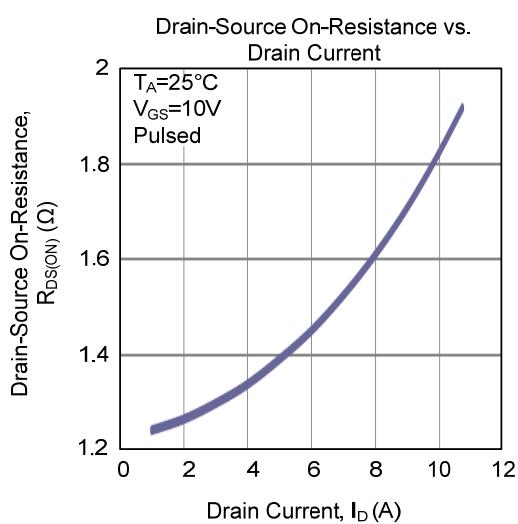
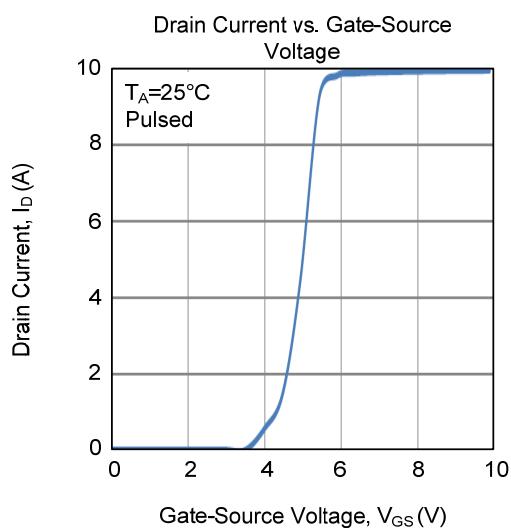
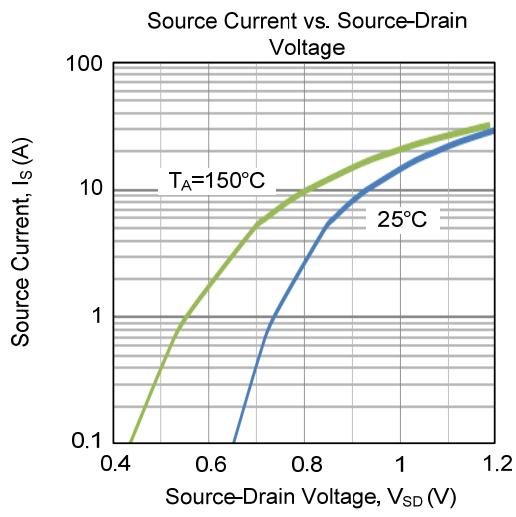
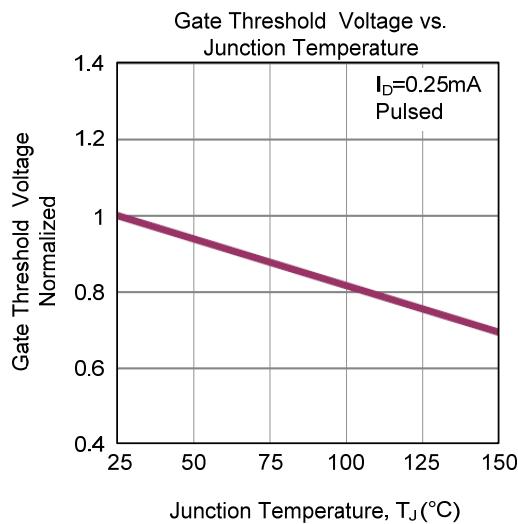
Notes: 1. Essentially independent of operating temperature.

2. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)

